

US00D549231S

(12) **United States Design Patent** (10) **Patent No.:** **US D549,231 S**
Doyle et al. (45) **Date of Patent:** **** Aug. 21, 2007**

(54) **COVER FOR AN EMI SHIELD ASSEMBLY**
 (75) Inventors: **Peter John Doyle**, Los Altos, CA (US);
Gerald Robert English, Glen Ellyn, IL (US);
Allan Richard Zuehlsdorf, Sycamore, IL (US);
Aleksey Pirkhalo, Buffalo Grove, IL (US)

5,383,098 A 1/1995 Ma et al.
 5,422,433 A 6/1995 Rivera et al.
 5,436,802 A 7/1995 Trahan et al.

(Continued)

FOREIGN PATENT DOCUMENTS

WO WO98/54942 12/1998

OTHER PUBLICATIONS

Pending U.S. Appl. No. 29/224, 131, filed Feb. 25, 2005, Latawiec et al.

(Continued)

(73) Assignee: **Laird Technologies, Inc.**, St. Louis, MO (US)

(**) Term: **14 Years**

(21) Appl. No.: **29/244,956**

(22) Filed: **Dec. 16, 2005**

(51) **LOC (8) Cl.** **14-02**

(52) **U.S. Cl.** **D14/432**

(58) **Field of Classification Search** D14/438-39,
 D14/432, 435-36; 439/939, 607, 159, 160,
 439/946, 630, 152; 174/35 R, 51, 35 C,
 174/35 GC, 378, 384, 387, 363, 372, 382,
 174/390, 366, 377, 354, 371, DIG. 34, DIG. 35;
 361/816, 800, 752, 797, 818, 801, 736, 810,
 361/756, 796; 29/832, 840-1; D13/173,
 D13/199; 220/4.02

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

1,257,502 A 2/1918 Leighton
 2,016,225 A 10/1935 Bukolt
 4,705,916 A 11/1987 Wadhwa et al.
 4,754,101 A 6/1988 Stickney et al.
 5,008,779 A * 4/1991 Salmon 361/797
 5,095,177 A 3/1992 Johnson
 5,153,379 A 10/1992 Guzik et al.
 D331,396 S 12/1992 Benck et al.
 5,175,395 A 12/1992 Moore
 5,252,782 A * 10/1993 Cantrell et al. 174/387
 5,354,951 A 10/1994 Lange, Sr. et al.
 5,365,410 A 11/1994 Lonka

Primary Examiner—M. H. Tung
Assistant Examiner—Susan Moon Lee
 (74) *Attorney, Agent, or Firm*—Harness, Dickey & Pierce, P.L.C.

(57) **CLAIM**

We claim the ornamental design for a cover for an EMI shield assembly, as shown and described.

DESCRIPTION

FIG. 1 is a reduced outer perspective view of the cover for an EMI shield assembly showing our new design;

FIG. 2 is a reduced inner perspective view of the cover for an EMI shield assembly shown in FIG. 1;

FIG. 3 is a top plan view of the cover shown in FIG. 1;

FIG. 4 is a bottom plan view of the cover shown in FIG. 1;

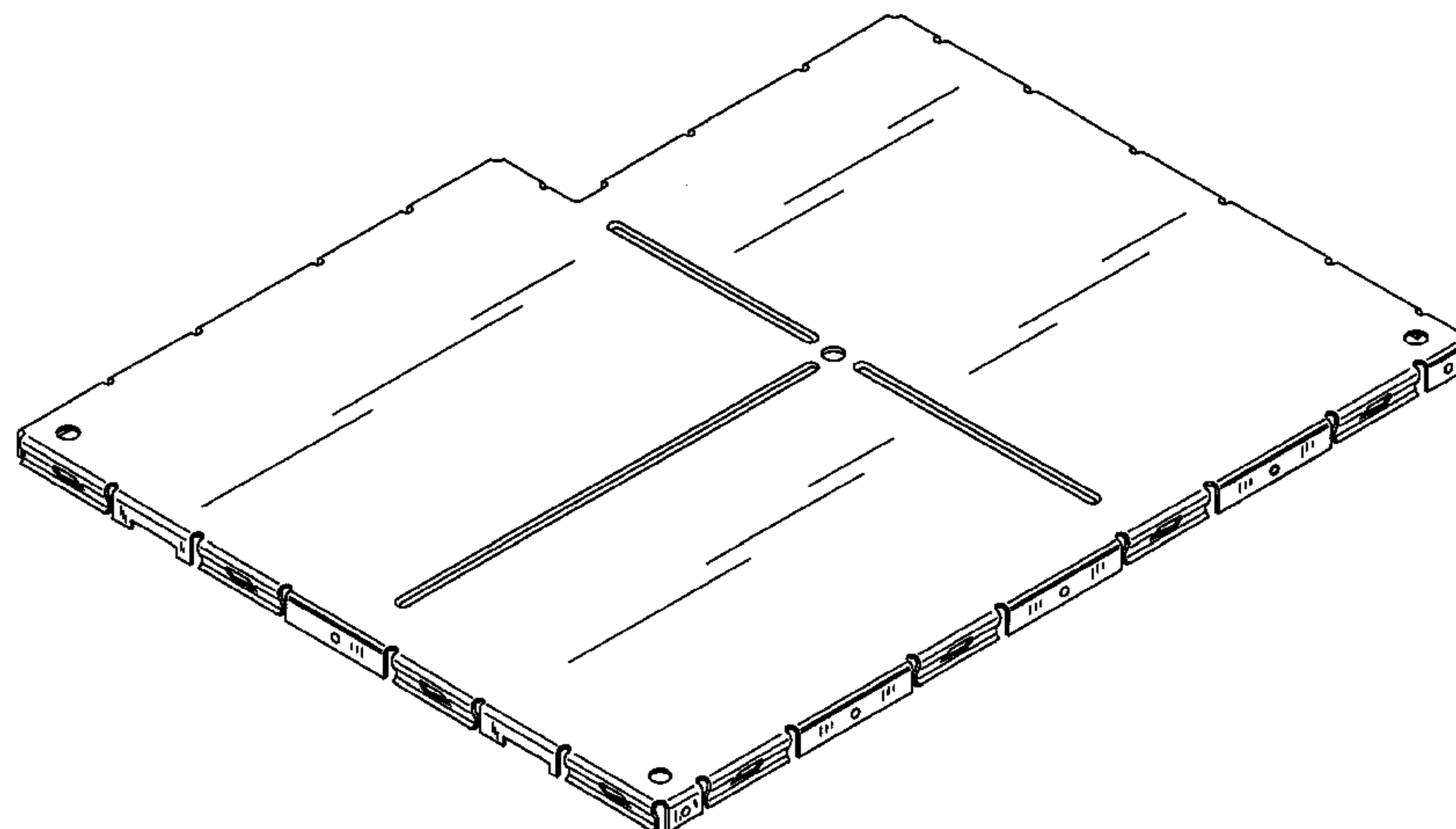
FIG. 5 is a front elevation view of the cover shown in FIG. 1;

FIG. 6 is a rear elevation view of the cover shown in FIG. 1;

FIG. 7 is a left side elevation view of the cover for an EMI shield assembly shown in FIG. 1; and,

FIG. 8 is a right side elevation view of the cover for an EMI shield assembly shown in FIG. 1.

1 Claim, 5 Drawing Sheets



US D549,231 S

Page 2

U.S. PATENT DOCUMENTS

5,469,982	A *	11/1995	Gordecki et al.	220/4.02	
5,495,399	A	2/1996	Gore et al.		
5,513,996	A	5/1996	Annerino et al.		
5,530,202	A	6/1996	Dais et al.		
5,566,055	A	10/1996	Salvi, Jr.		
5,614,694	A	3/1997	Gorenz, Jr. et al.		
5,774,344	A *	6/1998	Casebolt	361/800	
D397,097	S	8/1998	McNally		
5,844,784	A	12/1998	Moran et al.		
5,886,879	A	3/1999	Matuschik		
5,895,884	A	4/1999	Davidson		
5,917,710	A	6/1999	Maatta		
5,991,165	A	11/1999	Jones, Jr. et al.		
6,005,186	A	12/1999	Bachman		
6,043,983	A	3/2000	Taylor et al.		
6,049,469	A	4/2000	Hood, III et al.		
6,051,781	A	4/2000	Bianca et al.		
6,110,563	A	8/2000	Pienimaa et al.		
6,121,545	A	9/2000	Peng et al.		
6,136,131	A	10/2000	Sosnowski		
6,137,692	A *	10/2000	Venant	361/800	
6,150,606	A *	11/2000	Matsumoto et al.	174/384	
6,152,779	A *	11/2000	Madsen et al.	439/676	
D434,771	S	12/2000	Ohtani		
6,169,665	B1 *	1/2001	Lepping et al.	361/800	
6,175,077	B1	1/2001	Mendolia et al.		
6,178,097	B1	1/2001	Hauk, Jr.		
6,191,950	B1 *	2/2001	Cox et al.	361/737	
6,265,658	B1	7/2001	Silvers		
6,274,808	B1	8/2001	Cercioglu et al.		
6,288,330	B1 *	9/2001	Chen	174/382	
6,313,400	B1	11/2001	Mosquera et al.		
6,320,121	B1 *	11/2001	Honeycutt et al.	174/384	
6,377,472	B1	4/2002	Fan		
6,384,324	B2	5/2002	Flegeo		
6,483,719	B1	11/2002	Bachman		
6,501,016	B1	12/2002	Sosnowski		
6,552,261	B2	4/2003	Shlahtichman et al.		
6,628,524	B1	9/2003	Washino et al.		
6,629,860	B1 *	10/2003	Hu et al.	439/607	
6,636,428	B2 *	10/2003	Follmer et al.	361/797	
D484,508	S	12/2003	Crippen et al.		
6,671,183	B2 *	12/2003	Tsuzuki	361/797	
6,674,653	B1 *	1/2004	Valentine	361/818	
6,711,032	B2	3/2004	Sommer		
6,717,799	B2	4/2004	Hamano et al.		
6,731,518	B2 *	5/2004	Suzuki et al.	361/818	
6,738,265	B1	5/2004	Svarfvar et al.		
6,743,975	B2	6/2004	Kolb		
6,744,640	B2	6/2004	Reis et al.		
6,763,576	B2	7/2004	Watchko et al.		
6,781,847	B2	8/2004	Jakob et al.		
6,781,851	B2	8/2004	Daoud et al.		
6,784,363	B2	8/2004	Jones		
6,787,696	B2	9/2004	Liljevik et al.		
6,870,091	B2	3/2005	Seidler		
6,949,705	B2	9/2005	West		
6,949,706	B2 *	9/2005	West	174/384	
7,004,771	B1 *	2/2006	Lee	439/159	
7,013,558	B2	3/2006	Bachman		
7,147,495	B2 *	12/2006	Kuo	439/159	
2002/0185294	A1	12/2002	Shlyakhtichman et al.		
2003/0011978	A1 *	1/2003	Moore	361/685	
2003/0016519	A1 *	1/2003	Bachman	361/818	
2003/0062179	A1 *	4/2003	West	174/35 R	
2003/0067757	A1	4/2003	Richardson et al		
2003/0128535	A1 *	7/2003	Otani et al.	361/816	
2004/0012939	A1	1/2004	Ta et al.		
2004/0025334	A1 *	2/2004	Wen et al.	29/832	
2005/0121212	A1	6/2005	English et al.		
2006/0012969	A1	1/2006	Bachman		

OTHER PUBLICATIONS

Pending U.S. Appl. No. 11/245,306, filed Oct. 6, 2005, Zuehlsdorf et al.

* cited by examiner

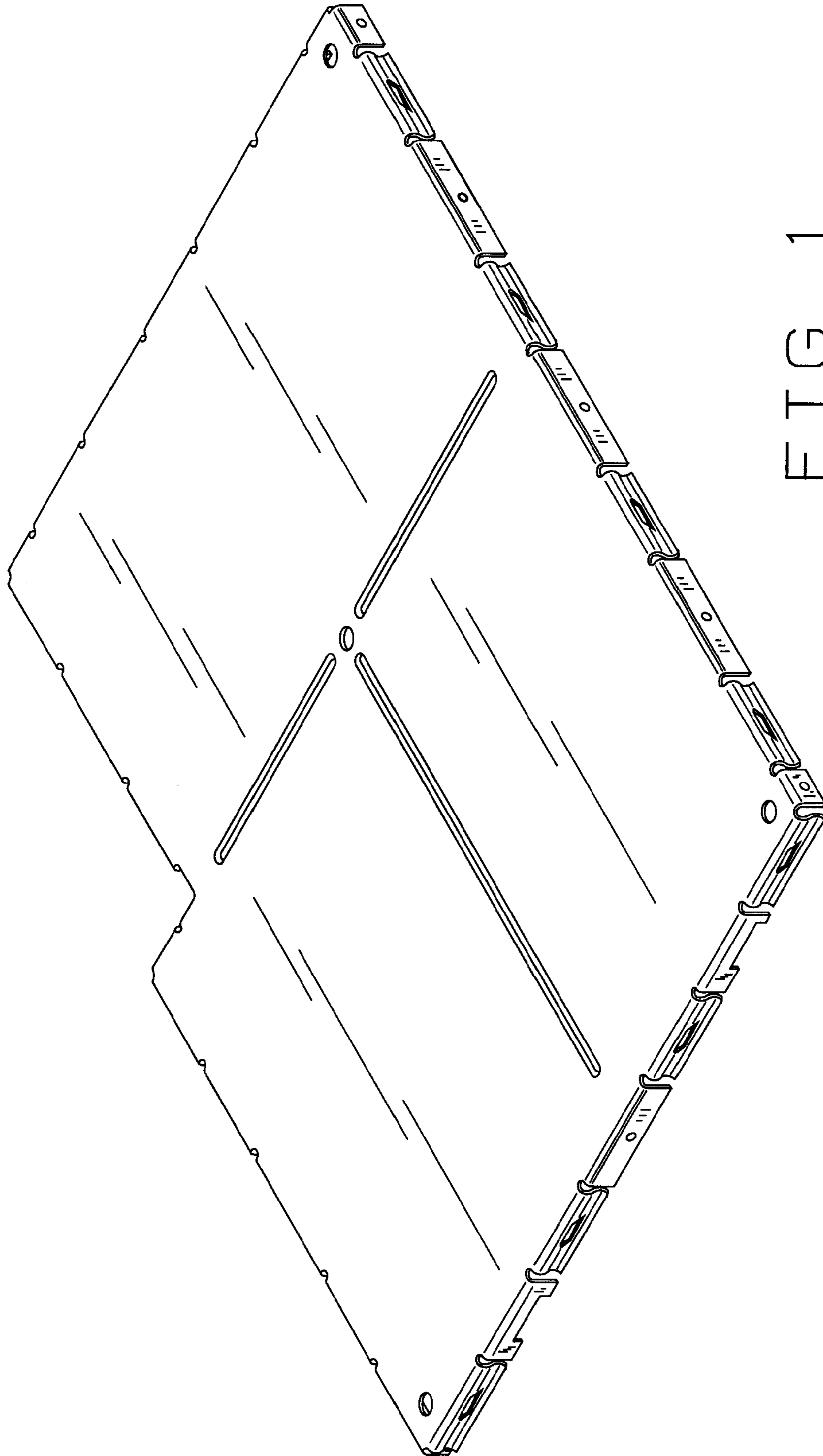


FIG. 1

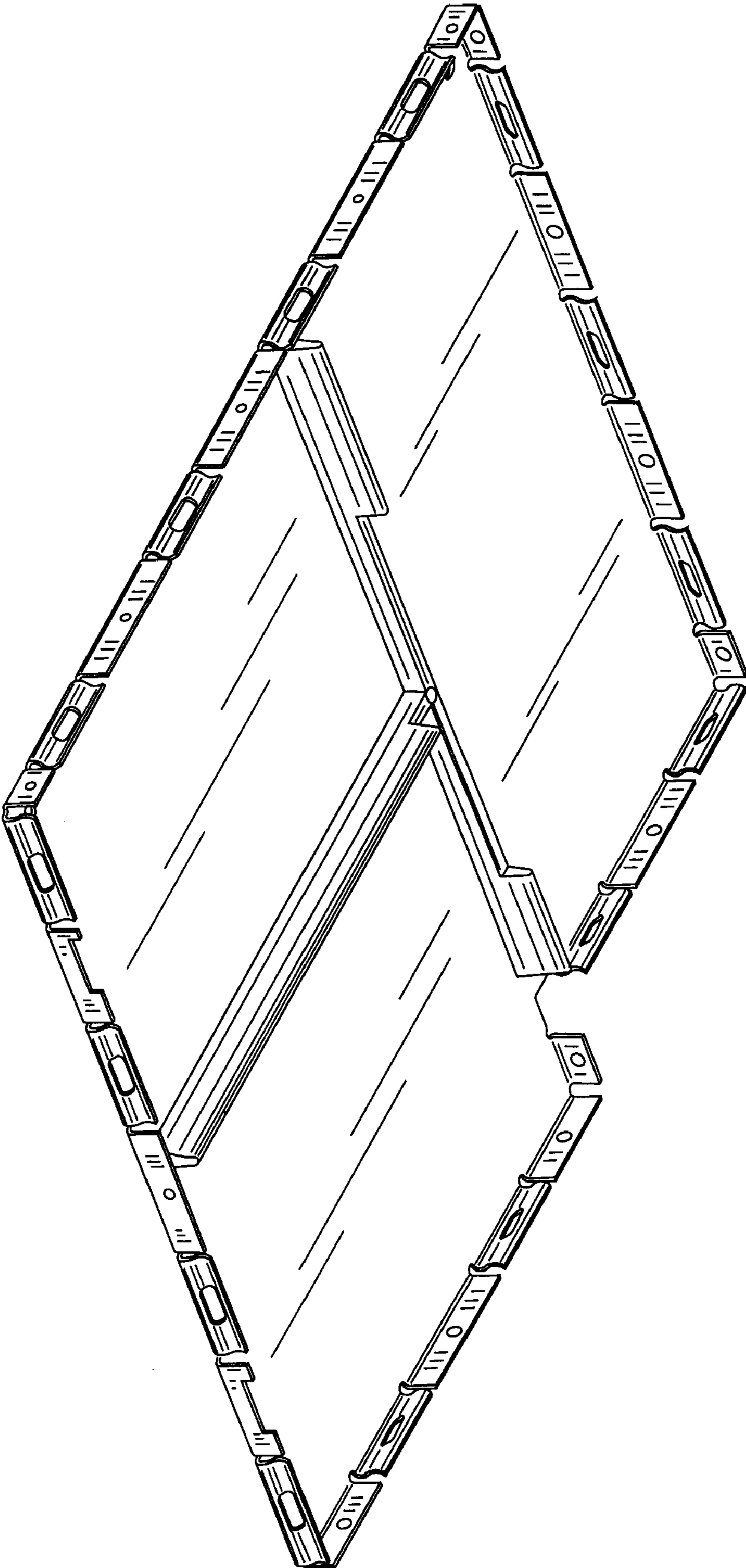


FIG. 2

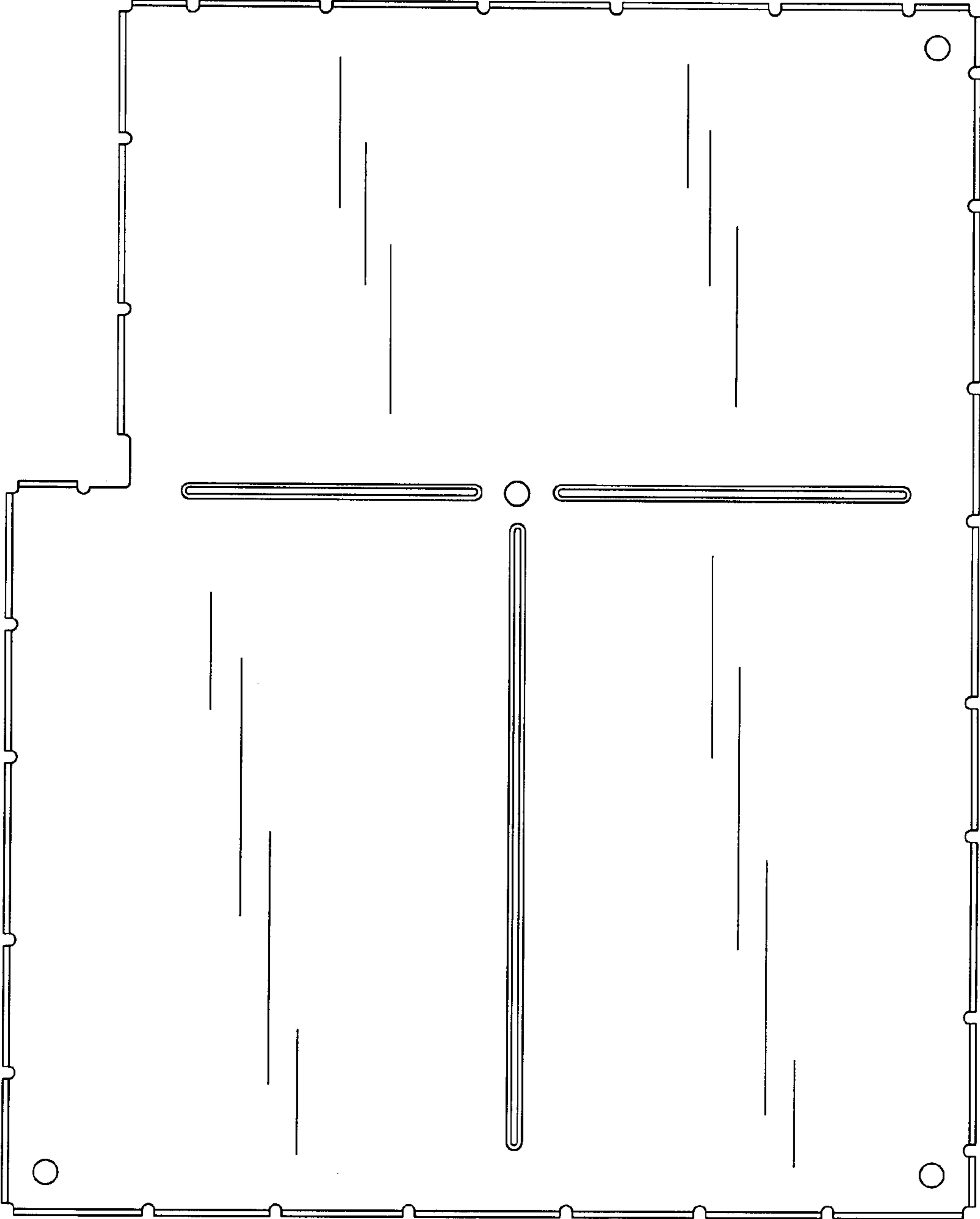


FIG. 3

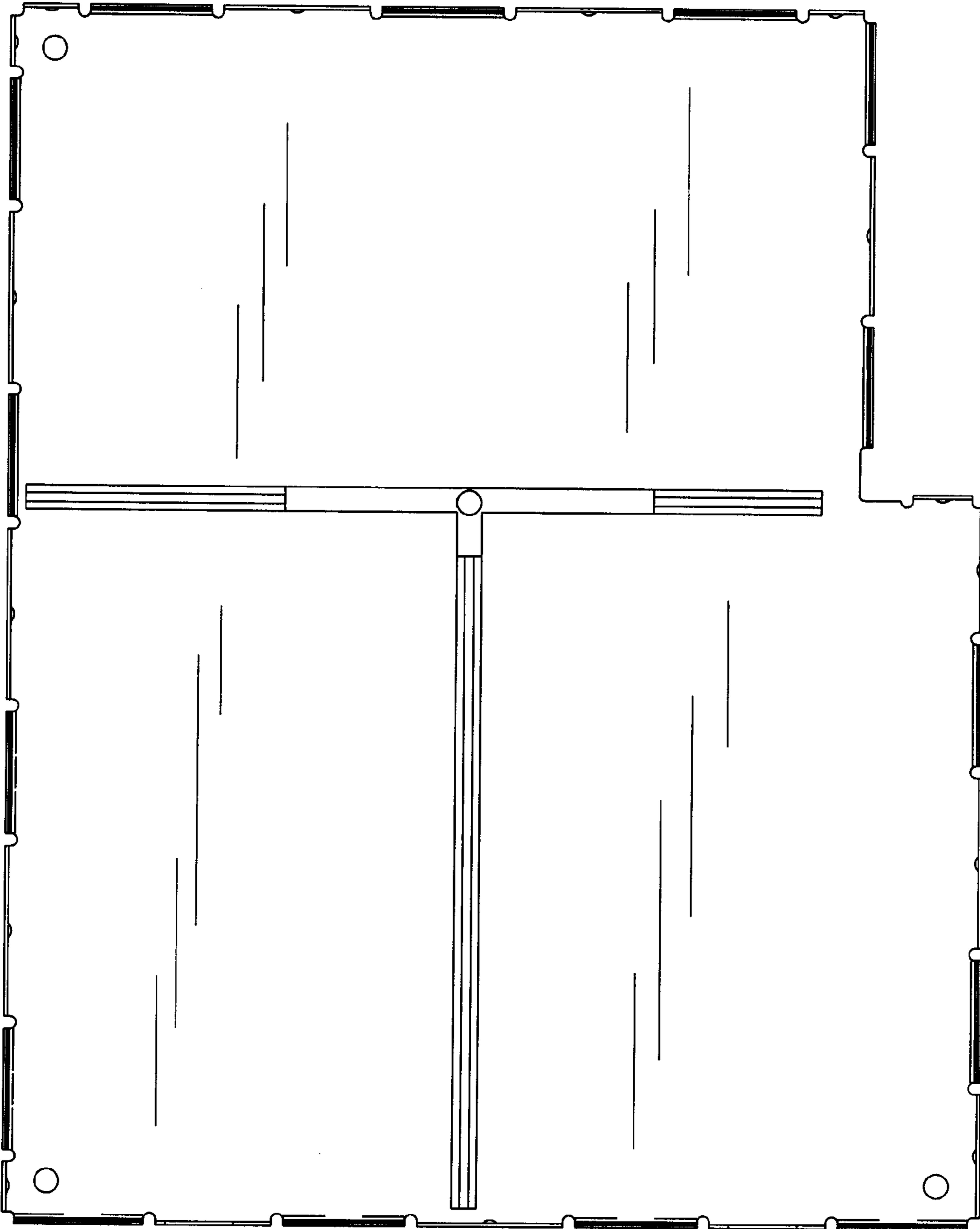


FIG. 4

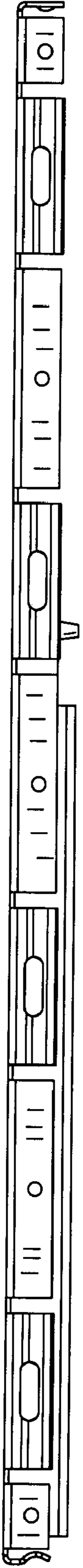


FIG. 5

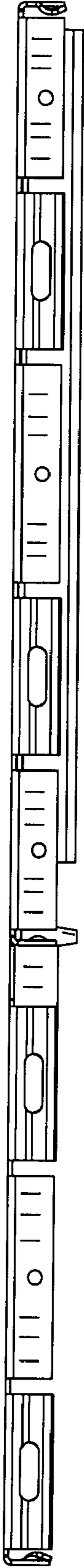


FIG. 6

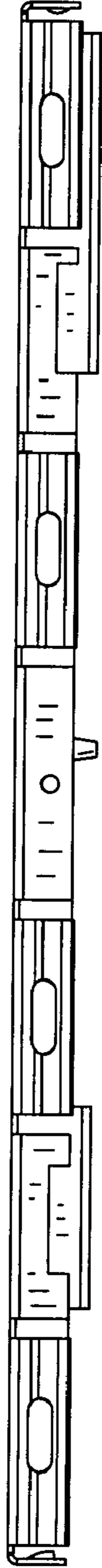


FIG. 7

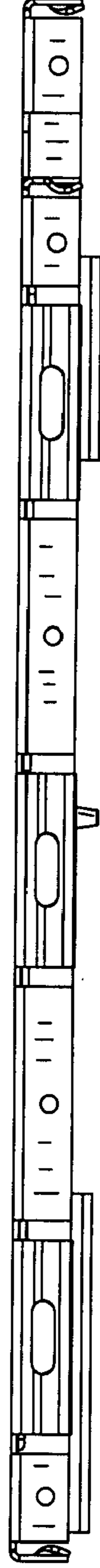


FIG. 8